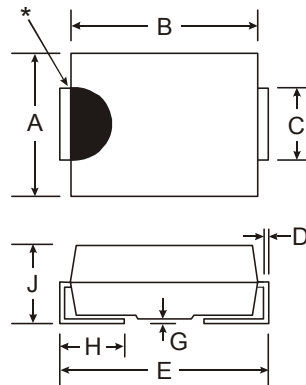


Features

- Guard Ring Die Construction for Transient Protection
- Ideally Suited for Automatic Assembly
- Low Power Loss, High Efficiency
- Surge Overload Rating to 100A Peak
- For Use in Low Voltage, High Frequency Inverters, Free Wheeling, and Polarity Protection Application
- **Lead Free Finish/RoHS Compliant (Note 4)**



Dim	SMA	
	Min	Max
A	2.29	2.92
B	4.00	4.60
C	1.27	1.63
D	0.15	0.31
E	4.80	5.59
G	0.10	0.20
H	0.76	1.52
J	2.01	2.30
All Dimensions in mm		

*: Note: Device may have a semicircular indentation/ notch on one side of the device (as shown).

Mechanical Data

- Case: SMA
- Case Material: Molded Plastic. UL Flammability Classification 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminals: Lead Free Plating (Matte Tin Finish). Solderable per MIL-STD-202, Method 208 (e3)
- Polarity: Cathode Band
- Marking Information: See Page 3
- Ordering Information: See Page 3
- Approximate Weight: SMA 0.064 grams

B340A-13-F

Maximum Ratings and Electrical Characteristics @T_A = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.
For capacitive load, derate current by 20%.

Characteristic	Symbol	B320A	B330A	B340A	B350A	B360A	Unit
Peak Repetitive Reverse Voltage	V _{RRM}			40	50	60	V
Working Peak Reverse Voltage	V _{RWM}	20	30	40	50	60	V
DC Blocking Voltage	V _R			40	50	60	V
RMS Reverse Voltage	V _{R(RMS)}	14	21	28	35	42	V
Average Rectified Output Current @ T _T = 100°C	I _O	3.0					A
Non-Repetitive Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load	I _{FSM}	80					A
Forward Voltage (Note 3) @ I _F = 3.0A	V _{FM}	0.50			0.70		V
Peak Reverse Current @ T _A = 25°C at Rated DC Blocking Voltage (Note 3) @ T _A = 100°C	I _{RM}	0.5					mA
Typical Capacitance (Note 2)	C _T	200					pF
Typical Thermal Resistance, Junction to Terminal	R _{θJT}	25					°C/W
Typical Thermal Resistance, Junction to Ambient (Note 1)	R _{θJA}	100					°C/W
Operating Temperature Range	T _j	-55 to +125					°C
Storage Temperature Range	T _{STG}	-55 to +150					°C

- Notes:
1. Thermal Resistance: Junction to terminal, unit mounted on glass epoxy substrate with 2x3mm copper pad.
 2. Measured at 1.0 MHz and applied reverse voltage of 4.0V DC.
 3. Short duration pulse test used to minimize self-heating effect.
 4. RoHS revision 13.2.2003. High temperature solder exemption applied, see *EU Directive Annex Note 7*.

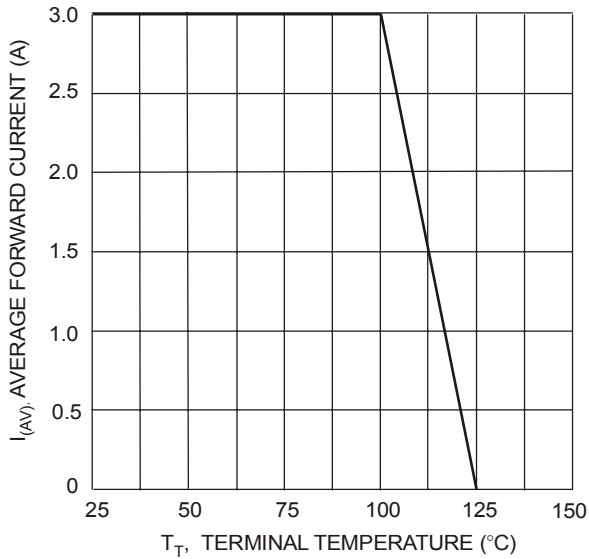


Fig. 1 Forward Current Derating Curve

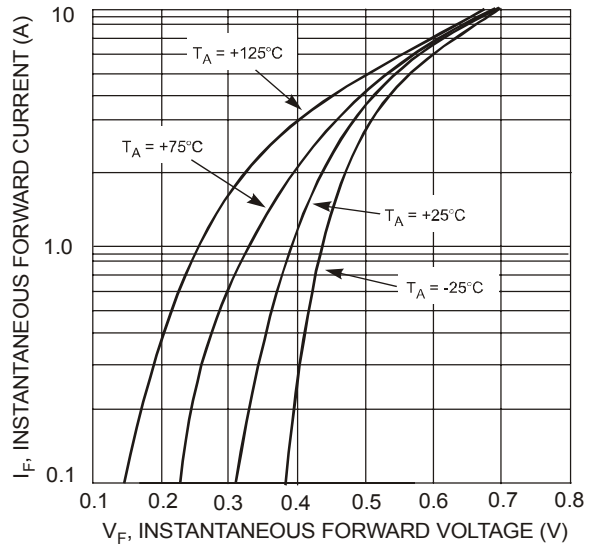


Fig. 2 Typical Forward Characteristics - B320A thru B340A

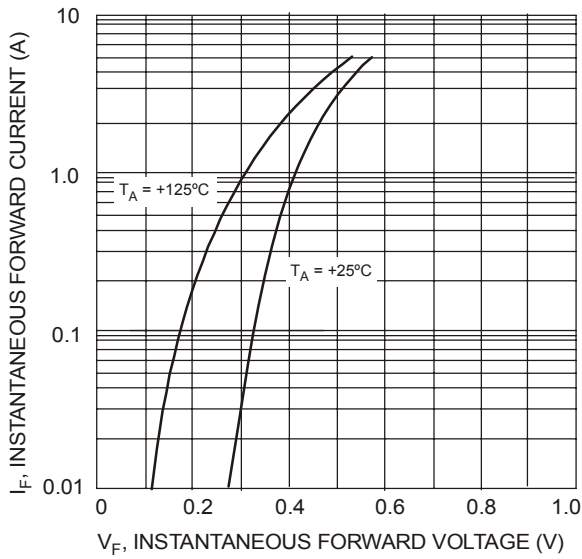


Fig. 3 Typ. Forward Characteristics - B350A thru B360A

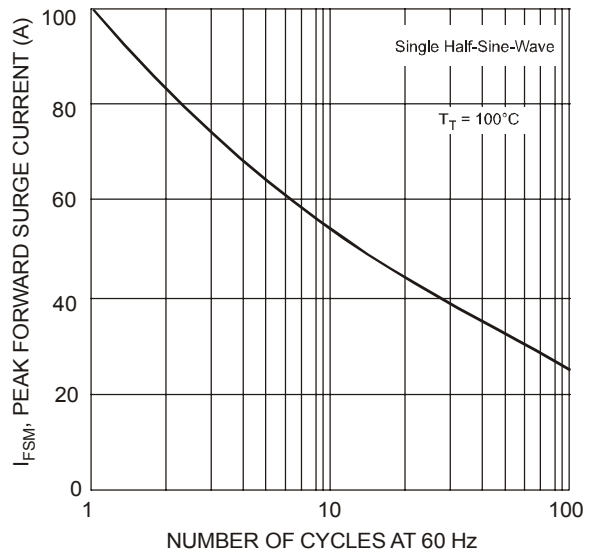


Fig. 4 Max Non-Repetitive Peak Fwd Surge Current

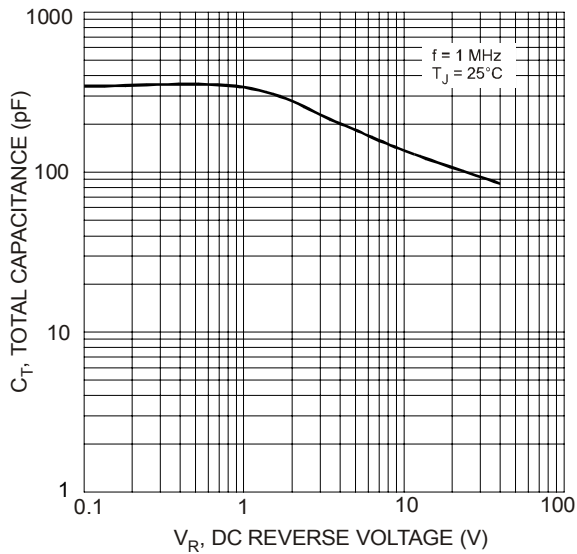


Fig. 5 Typical Capacitance

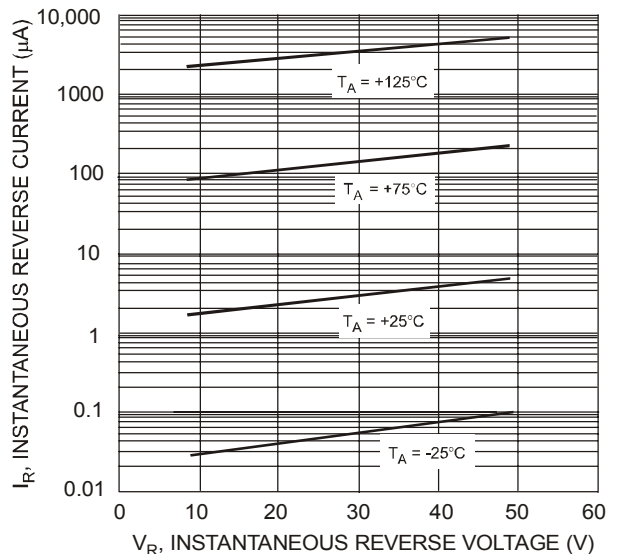
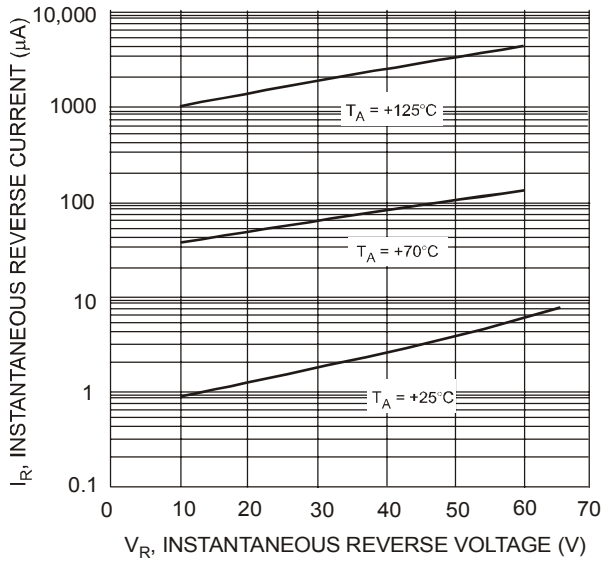


Fig. 6 Typical Reverse Characteristics, B320A thru B340A



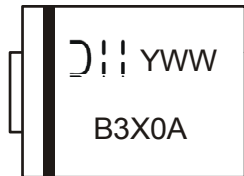
Ordering Information (Note 5)

Device*	Packaging	Shipping
B3XXA-13-F	SMA	5000/Tape & Reel

Notes: 5. For packaging details, go to our website at <http://www.diodes.com/datasheets/ap02007.pdf>.

* xx = Device type, e.g. B320A-13-F (SMA package).

Marking Information



B3X0A = Product type marking code, ex: B320A
 ☺|| = Manufacturers' code marking
 YWW = Date code marking
 Y = Last digit of year ex: 2 for 2002
 WW = Week code 01 to 52

Note: Device has a cathode band (as shown above) and may also have a cathode notch (as shown on Page 1).

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